## **SiT5002 Preliminary** 80-220 MHz MEMS TCXO and VCTCXO



## **Features**

- Any frequency between 80.000001 and 220 MHz accurate to 6 decimal places
- 100% pin-to-pin drop-in replacement to quartz-based (VC)TCXO
- Frequency stability as low as ±5 ppm. Contact SiTime for tighter stability options
- Ultra low phase jitter: 0.5 ps (12 kHz to 20 MHz)
- Voltage control option with pull range from ±12.5 ppm to ±50 ppm
- LVCMOS/HCMOS compatible output
- Voltage control, standby, output enable or no connect modes
- Standard 4-pin packages: 2.5 x 2.0, 3.2 x 2.5, 5.0 x 3.2, 7.0 x 5.0 mm
- Outstanding silicon reliability of 2 FIT, 10 times better than quartz
- Pb-free, RoHs and REACH compliant

# **Applications**

■ Ideal for telecom, networking, smart meter, GPS and wireless applications







## **Electrical Characteristics**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Output Frequency Range	f	80.000001	-	220	MHz	
Initial Tolerance	F_init	-1.5	-	1.5	ppm	At 25°C after two reflows
Stability Over Temperature	F_stab	-5	-	+5	ppm	Over operating temperature range at rated nominal power supply voltage and load. (see ordering codes on page 5)
						Contact SiTime for tighter stability options.
Supply Voltage	F_vdd	-	0.05	-	ppm	±10% Vdd (±5% for Vdd = 1.8V)
Output Load	F_load	_	0.1	_	ppm	±10% of 15 pF load
First year Aging	F_aging	-2.5	_	+2.5	ppm	
10-year Aging		-4.0	-	+4.0	ppm	25°C
Operating Temperature Range	T_use	-20	1	+70	°C	Extended Commercial
		-40	-	+85	°C	Industrial
Supply Voltage	Vdd	1.71	1.8	1.89	V	Contact SiTime for any other supply voltage options.
		2.25	2.5	2.75	V	7
		2.52	2.8	3.08	V	7
		2.70	3.0	3.3	V	7
		2.97	3.3	3.63	V	7
Pull Range	PR	±12.5, ±25, ±50		ppm		
Upper Control Voltage	VC_U	Vdd-0.1	_	-	V	All Vdds. Voltage at which maximum deviation is guaranteed.
Control Voltage Range	VC_L	-	-	0.1	V	
Control Voltage Input Impedance	Z_vc	100	-	_	kΩ	
Frequency Change Polarity	-	F	ositive slope	9	-	
Control Voltage -3dB Bandwidth	V_BW	_	ı	8	kHz	
<b>Current Consumption</b>	ldd	_	31	33	mA	No load condition, f = 20 MHz, Vdd = 2.5V, 2.8V or 3.3V.
		_	29	31	mA	No load condition, f = 20 MHz, Vdd = 1.8V.
OE Disable Current	I_OD	-	1	31	mA	Vdd = 2.5V, 2.8V or 3.3V, OE = GND, output is Weakly Pulled
		_	-	30	mA	Vdd = 1.8 V. OE = GND, output is Weakly Pulled Down
Standby Current	I_std	-	-	70	μA	Vdd = 2.5V, 2.8V or 3.3V, ST = GND, output is Weakly Pulled Down.
		_	-	10	μA	Vdd = 1.8V. ST = GND, output is Weakly Pulled Down.
Duty Cycle	DC	45	-	55	%	All Vdds
LVCMOS Rise/Fall Time	Tr, Tf	-	1.5	2	ns	LVCMOS option. Default rise/fall time, All Vdds, 10% - 90% Vdd.
Output Voltage High	VOH	90%	-	-	Vdd	OH = -7 mA, IOL = 7 mA, (Vdd = 3.3V, 3.0V)
Output Voltage Low	VOL	-	ı	10%	Vdd	IOH = -4 mA, IOL = 4 mA, (Vdd = 2.8V, 2.5V) IOH = -2 mA, IOL = 2 mA, (Vdd = 1.8V)
Input Voltage High	VIH	70%	-	-	Vdd	Pin 1, OE or ST
Input Voltage Low	VIL	-	-	30%	Vdd	Pin 1, OE or ST
Input Pull-up Impedance	Z_in	_	100	250	kΩ	

Sunnyvale, CA 94085 (408) 328-4400 www.sitime.com Revised November 12, 2015 Rev. 1.0

# 80-220 MHz MEMS TCXO and VCTCXO



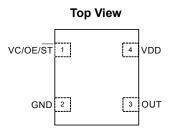
# **Electrical Characteristics (continued)**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Startup Time	T_start	-	-	10	ms	Measured from the time Vdd reaches its rated minimum value	
OE Enable/Disable Time	T_oe	-	-	150	ns	f = 80 MHz. For other frequencies, T_oe = 100 ns + 3 cycles	
Resume Time	T_resume	-	6	10	ms	Measured from the time ST pin crosses 50% threshold	
RMS Period Jitter	T_jitt	-	1.7	2	ps	f = 10 MHz, Vdd = 2.5V, 2.8V or 3.3V	
		_	1.7	2	ps	f = 10 MHz, Vdd = 1.8V	
RMS Phase Jitter (random)	T_phj	-	0.5	1	ps	f = 10 MHz, Integration bandwidth = 12 kHz to 20 MHz, All Vdds	

#### Note

# **Pin Configuration**

Pin	Symbol	Functionality		
		V control	Voltage control	
		Output Enable	H or Open <sup>[2]</sup> : specified frequency output L: output is high impedance. Only output driver is disabled.	
1	Standby		H or Open <sup>[2]</sup> : specified frequency output L: output is low (weak pull down). Device goes to sleep mode. Supply current reduces to I_std.	
		NC	No connect (input receiver off)	
2	GND	Power	Electrical and case ground	
3	CLK	Output	Oscillator output	
4	VDD	Power	Power supply voltage	



#### Note:

2. A pull-up resistor of <10 k? between OE/\$\overline{ST}\$ pin and Vdd is recommended in high noise environment when the device operates in OE/\$\overline{ST}\$ mode.

## **Absolute Maximum**

Attempted operation outside the absolute maximum ratings of the part may cause permanent damage to the part. Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

Parameter	Min.	Max.	Unit
Storage Temperature	-65	150	°C
VDD	-0.5	4	V
Electrostatic Discharge	-	2000	V
Soldering Temperature (follow standard Pb free soldering guidelines)	-	260	°C

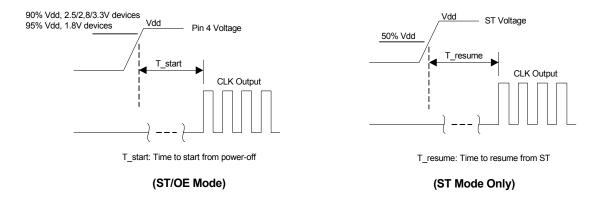
# **Environmental Compliance**

Parameter	Condition/Test Method
Mechanical Shock	MIL-STD-883F, Method 2002
Mechanical Vibration	MIL-STD-883F, Method 2007
Temperature Cycle	JESD22, Method A104
Solderability	MIL-STD-883F, Method 2003
Moisture Sensitivity Level	MSL1 @ 260°C

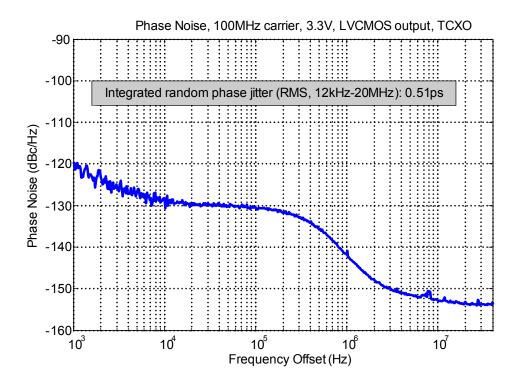
<sup>1.</sup> All electrical specifications in the above table are measured with 15pF output load, Contact SiTime for higher drive options.



# **Timing Diagram**



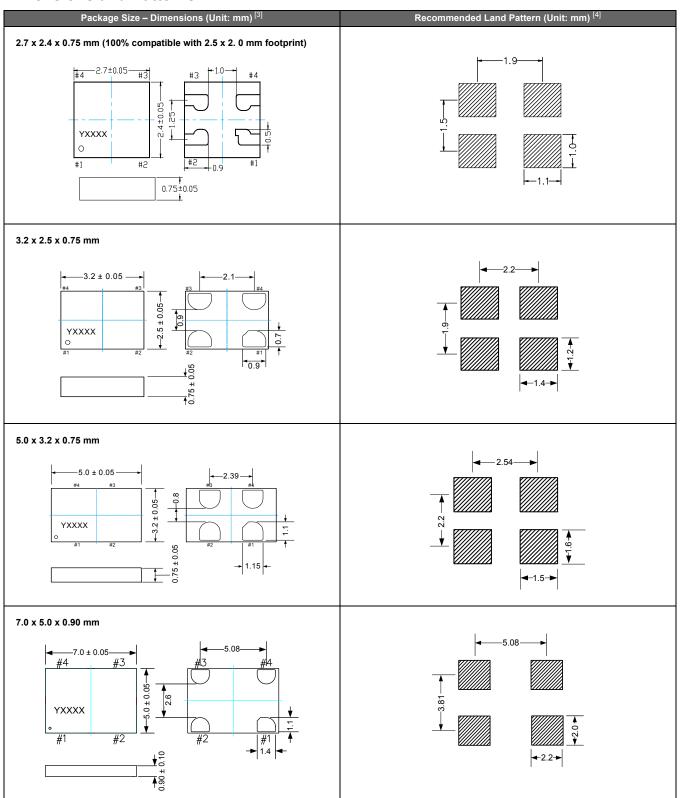
## **Phase Noise Plot**



# 80-220 MHz MEMS TCXO and VCTCXO



# **Dimensions and Patterns**



# Notes:

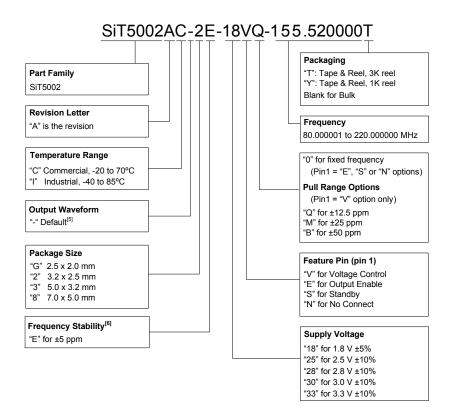
- 3. Top marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of "Y" will depend on the assembly location of the device.
- 4. A capacitor of value 0.1  $\mu\text{F}$  between Vdd and GND is recommended.

# 80-220 MHz MEMS TCXO and VCTCXO



# **Ordering Information**

The Part No. Guide is for reference only. To customize and build an exact part number, use the SiTime Part Number Generator.



#### Notes:

- 5. SiTime's SoftEdge™ output waveform with 6 ns rise/fall time reduces EMI and is similar to clipped sine wave in functionality.
- 6. Contact SiTime for tighter stability options.

# 80-220 MHz MEMS TCXO and VCTCXO



#### **Additional Information**

Document	Description	Download Link
Manufacturing Notes	Tape & Reel dimension, reflow profile and other manufacturing related info	http://www.sitime.com/component/docman/doc_download/85-manufacturing-notes-for-sitime-oscillators
Qualification Reports	RoHS report, reliability reports, composition reports	http://www.sitime.com/support/quality-and-reliability
Performance Reports	Additional performance data such as phase noise, current consumption and jitter for selected frequencies	http://www.sitime.com/support/performance-measurement-report
Termination Techniques	Termination design recommendations	http://www.sitime.com/support/application-notes
Layout Techniques	Layout recommendations	http://www.sitime.com/support/application-notes

# **Revision History**

Version	Release Date	Change Summary
1.0	11/12/15	Final production release  Revised initial tolerance, stability over temperature and first/10 year aging values in the electrical characteristics table  Revised frequency stability option

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# **Supplemental Information**

The Supplemental Information section is not part of the datasheet and is for informational purposes only.



# Silicon MEMS Outperforms Quartz

# Silicon MEMS Outperforms Quartz



## **Best Reliability**

Silicon is inherently more reliable than quartz. Unlike quartz suppliers, SiTime has in-house MEMS and analog CMOS expertise, which allows SiTime to develop the most reliable products. Figure 1 shows a comparison with quartz technology.

### Why is SiTime Best in Class:

- SiTime's MEMS resonators are vacuum sealed using an advanced EpiSeal<sup>™</sup> process, which eliminates foreign particles and improves long term aging and reliability
- · World-class MEMS and CMOS design expertise

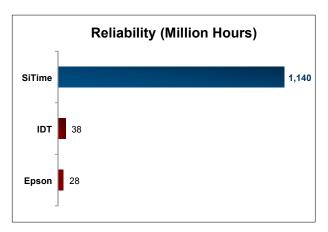


Figure 1. Reliability Comparison<sup>[1]</sup>

### **Best Aging**

Unlike quartz, MEMS oscillators have excellent long term aging performance which is why every new SiTime product specifies 10-year aging. A comparison is shown in Figure 2.

#### Why is SiTime Best in Class:

- SiTime's MEMS resonators are vacuum sealed using an advanced EpiSeal process, which eliminates foreign particles and improves long term aging and reliability
- Inherently better immunity of electrostatically driven MEMS resonator

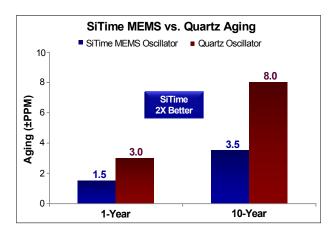


Figure 2. Aging Comparison<sup>[2]</sup>

## **Best Electro Magnetic Susceptibility (EMS)**

SiTime's oscillators in plastic packages are up to 54 times more immune to external electromagnetic fields than quartz oscillators as shown in Figure 3.

### Why is SiTime Best in Class:

- Internal differential architecture for best common mode noise rejection
- Electrostatically driven MEMS resonator is more immune to EMS

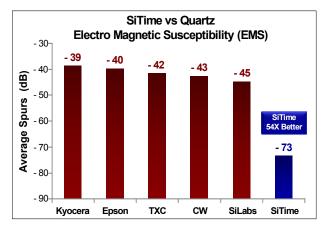


Figure 3. Electro Magnetic Susceptibility (EMS)[3]

### **Best Power Supply Noise Rejection**

SiTime's MEMS oscillators are more resilient against noise on the power supply. A comparison is shown in Figure 4.

#### Why is SiTime Best in Class:

- On-chip regulators and internal differential architecture for common mode noise rejection
- · Best analog CMOS design expertise

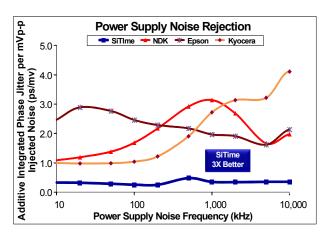


Figure 4. Power Supply Noise Rejection<sup>[4]</sup>

# Silicon MEMS Outperforms Quartz



### **Best Vibration Robustness**

High-vibration environments are all around us. All electronics, from handheld devices to enterprise servers and storage systems are subject to vibration. Figure 5 shows a comparison of vibration robustness.

### Why is SiTime Best in Class:

- The moving mass of SiTime's MEMS resonators is up to 3000 times smaller than guartz
- Center-anchored MEMS resonator is the most robust design

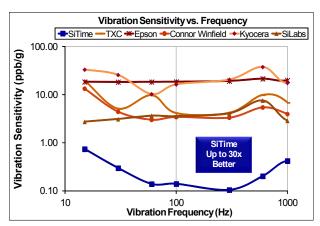


Figure 5. Vibration Robustness<sup>[5]</sup>

#### Notes:

- 1. Data Source: Reliability documents of named companies.
- 2. Data source: SiTime and quartz oscillator devices datasheets.
- 3. Test conditions for Electro Magnetic Susceptibility (EMS):
  - According to IEC EN61000-4.3 (Electromagnetic compatibility standard)
  - Field strength: 3V/m
  - Radiated signal modulation: AM 1 kHz at 80% depth
  - Carrier frequency scan: 80 MHz 1 GHz in 1% steps
  - · Antenna polarization: Vertical
  - DUT position: Center aligned to antenna

#### Devices used in this test:

SiTime, SiT9120AC-1D2-33E156.250000 - MEMS based - 156.25 MHz

Epson, EG-2102CA 156.2500M-PHPAL3 - SAW based - 156.25 MHz

TXC, BB-156.250MBE-T - 3rd Overtone quartz based - 156.25 MHz

Kyocera, KC7050T156.250P30E00 - SAW based - 156.25 MHz

Connor Winfield (CW), P123-156.25M - 3rd overtone quartz based - 156.25 MHz

SiLabs, Si590AB-BDG - 3rd overtone quartz based - 156.25 MHz

4. 50 mV pk-pk Sinusoidal voltage.

#### Devices used in this test:

SiTime, SiT8208AI-33-33E-25.000000, MEMS based - 25 MHz

NDK, NZ2523SB-25.6M - quartz based - 25.6 MHz

Kyocera, KC2016B25M0C1GE00 - quartz based - 25 MHz

Epson, SG-310SCF-25M0-MB3 - quartz based - 25 MHz

- 5. Devices used in this test: same as EMS test stated in Note 3.
- 6. Test conditions for shock test:
  - MIL-STD-883F Method 2002
  - Condition A: half sine wave shock pulse, 500-g, 1ms
  - $\bullet$  Continuous frequency measurement in 100  $\mu s$  gate time for 10 seconds

Devices used in this test: same as EMS test stated in Note 3

7. Additional data, including setup and detailed results, is available upon request to qualified customers. Please contact productsupport@sitime.com.

## **Best Shock Robustness**

SiTime's oscillators can withstand at least  $50,000\ g$  shock. They all maintain their electrical performance in operation during shock events. A comparison with quartz devices is shown in Figure 6.

### Why is SiTime Best in Class:

- The moving mass of SiTime's MEMS resonators is up to 3000 times smaller than guartz
- Center-anchored MEMS resonator is the most robust design

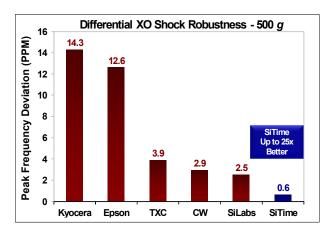


Figure 6. Shock Robustness<sup>[6]</sup>

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